

QC标准-详解

阳极/电泳工艺导致的内部挂具点无法避免请见谅

灯光:常见室内100w稳定且无方向性的光源,垂直照射被观测面

■A级外观面:完整组装整个键盘后最直观视觉区域

■A-级外观面:仅组装壳体后除A+外视觉区域

■B级内侧面:组装后内侧不可见区域

■B-级内侧面:组装后部件相互贴合区域

阳极氧化、电泳涂层部件可能缺点说明

A级与A-级面不允许有划痕/亮纹/暗纹/刀纹毛刺允许A级面存在瑕疵点 \leq 0.2mm,每面 \leq 1个允许A-级面存在瑕疵点 \leq 0.25mm,每面 \leq 2个,两点距离 \geq 80mm存在缺点的A和A-级面在每一个部件上 \leq 2,在全套件上 \leq 5允许表面处理不可避免的挂点大小 \leq 3mm螺孔露白区域大小 \leq 3mm,数量 \leq 4个

PVD部件外观可能缺点说明

A级面不允许存在划痕/亮纹/暗纹/刀纹 瑕疵点 \leq 0.2mm,每个面 \leq 2个,间距 \leq 100mm A-级面不允许出现亮纹/暗纹/刀纹,允许存在划痕长度 \leq 2mm,允许存在瑕疵点 \leq 0.3mm,每个面 \leq 4个,间距 \leq 80mm 存在缺点的A和A-级面在每一个部件上 \leq 1.在全套件上 \leq 2

QC Level-Expound The hanging marks of anode and e-coat cannot be avoided

Lighting: A common indoor 100w stable and non directional light source that vertically illuminates the observed surface

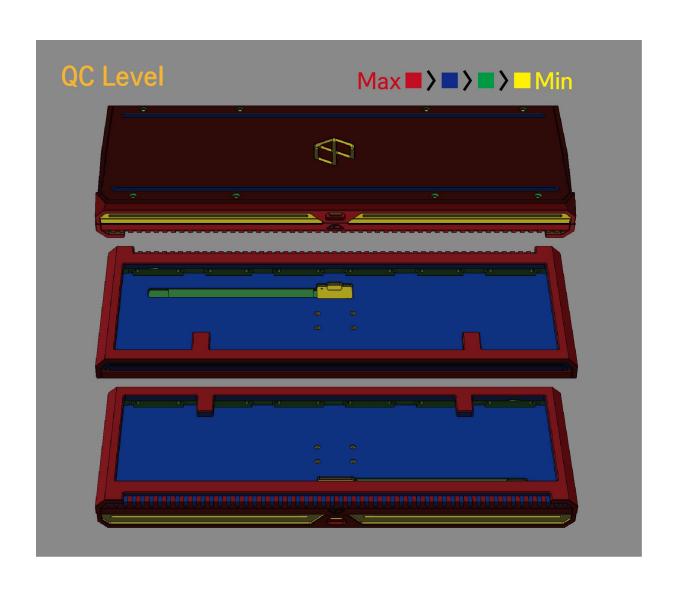
- level A surface: the most intuitive visual area after full assembly
- level A- surface: visual area except for level A after shell assembly
- level B inner side: the inner invisible area after assembly
- level B- inner side: mutual splicing area after assembly

Description of defects of Anodized and E-Coated components

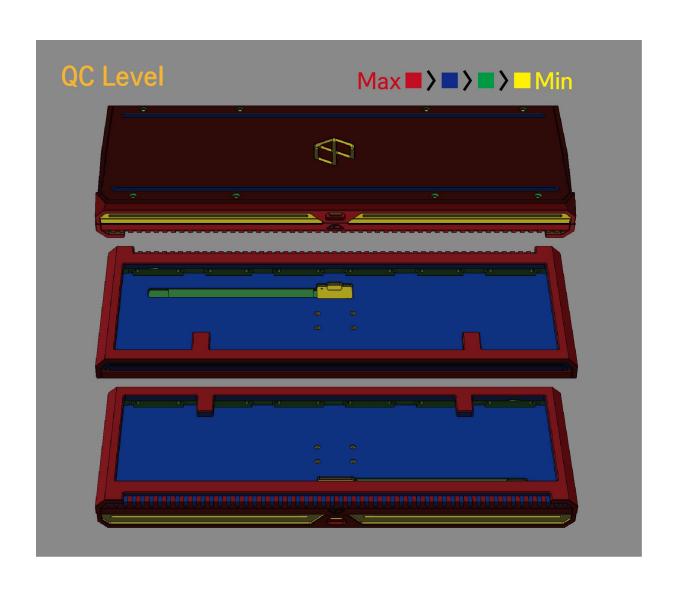
level A&A- surfaces without scratches/lines/knife marks/burrs level A surface may have defects ≤ 0.2 mm, ≤ 1 per surface level A- surface may have defects ≤ 0.25 mm, ≤ 2 per surface level A and A-Surfaces with defects ≤ 2 per part and ≤ 5 on entire kit size of inevitable anode mount point in surface treatment ≤ 3 mm size of screw hole color fading area ≤ 3 mm, quantity ≤ 4

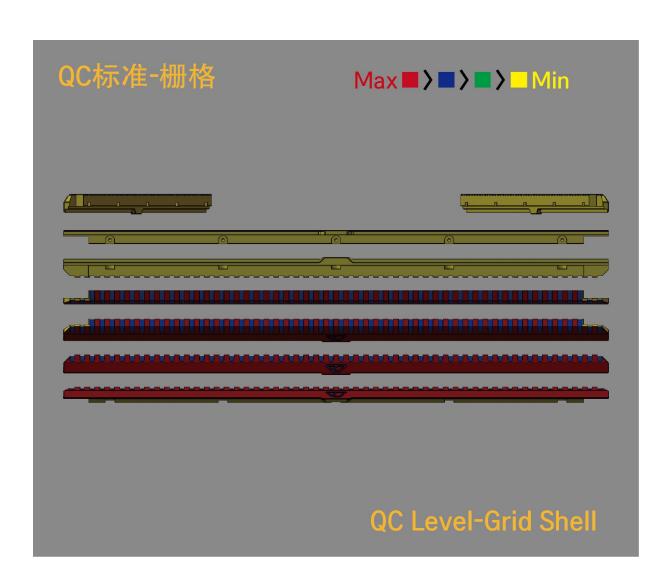
Description of Appearance Defects of PVD Components

level A surfaces without scratches/lines/knife marks Defect points ≤ 0.2 mm, ≤ 2 per surface, spacing ≤ 100 mm level A- surfaces without lines/knife marks, scratch length ≤ 2 mm, Defect points ≤ 0.3 mm, ≤ 4 per surface, spacing ≤ 80 mm level A and A-Surfaces with defects ≤ 1 per part and ≤ 2 on entire kit













在PCB背面使用双面胶 推荐位置如图所示



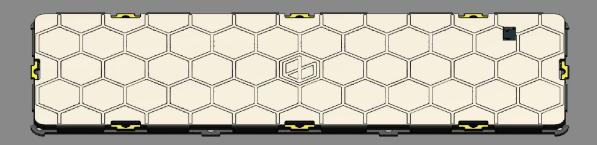
Use double-sided adhesive tape to the back of PCB The recommended location is shown in the picture

通过双面胶粘住PORON镂空底垫



Put 2mm PORON to double-sided adhesive tape on PCB

撕开回声纸层背胶并贴在PORON底垫和轴座上



Tear off the adhesive backing of the echo paper Attach it to the PORON and hotswap bases



请根据喜好决定硅胶支撑块的硬度 以及不同的支撑模式和位置



Choose the hardness of the silicone support block and pcb or plate-leaf even Dual-Leaf or any location you want

Assembly Step5





放入防轴座短路隔离PORON垫

这一步是不可省略的

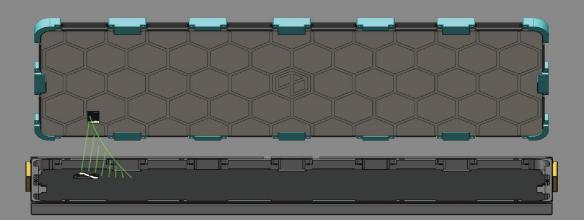


place the short-circuit- protection PORON pad

This step cannot be omitted

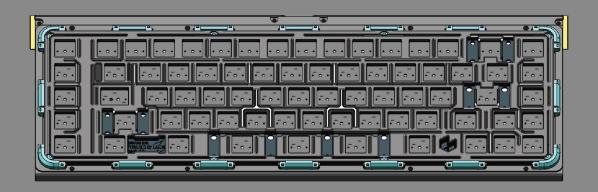


将FPC排线拉起一部分接入PCB的FPC插座 向后压紧插座开关确保不会轻易脱落



Pull up a portion of FPC cable link to socket on the PCB Pull socket switch back to ensure cable is pressed tight

将整个内胆对准硅胶块的卡槽放置进底壳里 需要确保每一个硅胶块都正确无偏差的落位



Align the entire inner kit with the slot Place it into the bottom shell without offset

将上壳也对准硅胶块的位置组合起来 确保内侧卡槽和底壳一样精准夹住硅胶 注意玻璃的摆放尽量在卡槽里左右居中 以免合最后装上壳时压碎边角

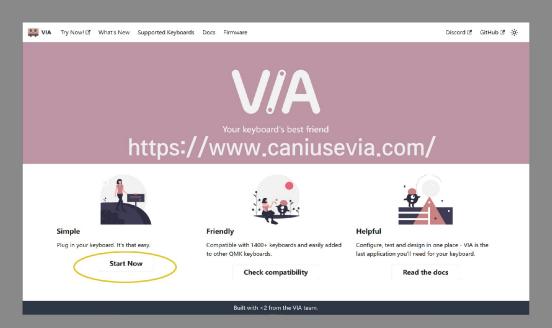


Align the upper shell with the position of silicone Ensure that slots of upper shell accurately grip them, Please place glass in the center of the slot to avoid crushing the glas corners when installing the cover



固件设置1

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Firmware Settings1

固件设置2

在此界面即可设置所有按键功能 左侧灯泡图标可设置RGB灯条功能



Set any key functions you need here Set the functions of light bars in the bulb logo

Firmware Settings2